

# μ**PG2418TB**

Data Sheet

GaAs Integrated Circuit 0.5 to 3.0 GHz SPDT Switch with 50  $\Omega$  Termination

R09DS0007EJ0100 Rev.1.00 Aug 24, 2010

# DESCRIPTION

The  $\mu$ PG2418TB is a GaAs MMIC for L, S-band SPDT (<u>Single Pole Double Throw</u>) switch with 50  $\Omega$  termination for 2.4 GHz wireless LAN, mobile phone and other L, S-band applications.

This device operates with dual control switching voltages of 2.5 to 5.3 V. This device can operate at frequencies from 0.5 to 3.0 GHz, with low insertion loss and high isolation.

This device is housed in a 6-pin super minimold package (SC-88/SOT-363 type), and is suitable for high-density surface mounting.

# FEATURES

•	Switch control voltage	: $V_{\text{cont (H)}} = 3.0 \text{ V TYP}.$
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- :  $V_{\text{cont (L)}} = 0 \text{ V TYP}.$
- Low insertion loss :  $L_{ins} = 0.45 \text{ dB TYP}$ . @ f = 2.5 GHz
- High isolation : ISL = 21 dB TYP. @ f = 2.5 GHz
  - Handling power :  $P_{in (0.1 dB)} = +29.0 dBm TYP$ . @ f = 0.5 to 3.0 GHz
- High-density surface mounting : 6-pin super minimold package (SC-88/SOT-363 type) (2.0 × 1.25 × 0.9 mm)

# APPLICATIONS

- W-LAN and Bluetooth<sup>TM</sup> etc.
- L, S-band digital cellular or cordless telephone

# ORDERING INFORMATION

Part Number	Order Number	Package	Marking	Supplying Form
μPG2418TB-E4	μPG2418TB-E4-A	6-pin super minimold	G6H	Embossed tape 8 mm wide
		(SC-88/SOT-363 type) (Pb-Free)		• Pin 4, 5, 6 face the perforation side of the tape
				Qty 3 kpcs/reel

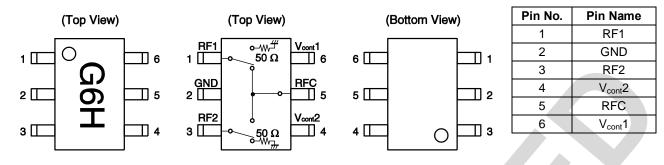
**Remark** To order evaluation samples, please contact your nearby sales office. Part number for sample order:  $\mu$ PG2418TB-A

#### CAUTION

Although this device is designed to be as robust as possible, ESD (Electrostatic Discharge) can damage this device. This device must be protected at all times from ESD. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD precautions must be employed at all times.



### PIN CONNECTIONS AND INTERNAL BLOCK DIAGRAM



#### SW TRUTH TABLE

ON Path	V <sub>cont</sub> 1	V <sub>cont</sub> 2
RFC-RF1	High	Low
RFC-RF2	Low	High

#### ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = +25°C, unless otherwise specified)

Parameter	Symbol	Ratings	Unit
Switch Control Voltage	V <sub>cont</sub>	+6.0 Note	V
Input Power (ON Port)	Pin	+33.0	dBm
Input Power (OFF Port)	Pin	+20.0	dBm
Operating Ambient Temperature	TA	-45 to +85	°C
Storage Temperature	T <sub>stg</sub>	-55 to +150	°C
Note: $ V_{1}  =  V_{2}  \le 6.0 V$			

Note:  $|V_{cont}1 - V_{cont}2| \le 6.0 V$ 

# **RECOMMENDED OPERATING RANGE (TA = +25°C, unless otherwise specified)**

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Operating Frequency	f	0.5		3.0	GHz
Switch Control Voltage (H)	V <sub>cont (H)</sub>	2.5	3.0	5.3	V
Switch Control Voltage (L)	Vcont (L)	-0.2	0	0.2	V
Control Voltage Difference	$\varDelta V_{cont (H)}$ ,	-0.1	0	0.1	V
	∆V <sub>cont (L)</sub> Note				

Note:  $\Delta V_{\text{cont (H)}} = V_{\text{cont}} \mathbf{1}_{(\text{H})} - V_{\text{cont}} \mathbf{2}_{(\text{H})}$  $\Delta V_{\text{cont}(L)} = V_{\text{cont}} \mathbf{1}_{(L)} - V_{\text{cont}} \mathbf{2}_{(L)}$ 



#### **ELECTRICAL CHARACTERISTICS**

 $(T_A = +25^{\circ}C, V_{cont (H)} = 3.0 V, V_{cont (L)} = 0 V, Z_O = 50 \Omega, DC blocking capacitors = 56 pF, unless otherwise specified)$ 

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Insertion Loss	L <sub>ins</sub>	f = 0.5 to 1.0 GHz	-	0.30	0.50	dB
		f = 1.0 to 2.0 GHz	-	0.37	0.57	dB
		f = 2.0 to 2.5 GHz	-	0.45	0.65	dB
		f = 2.5 to 3.0 GHz	-	0.50	0.70	dB
Isolation	ISL	f = 0.5 to 2.0 GHz	19	23	-	dB
		f = 2.0 to 2.5 GHz	17	21	-	dB
		f = 2.5 to 3.0 GHz	16	20	-	dB
Input Return Loss	RL <sub>in</sub>	f = 0.5 to 3.0 GHz	15	20	-	dB
Output Return Loss	RL <sub>out</sub>	f = 0.5 to 3.0 GHz	15	20	_	dB
Unused Port Return Loss	URL	f = 2.0 to 3.0 GHz	10	20	-	dB
0.1 dB Loss Compression	Pin (0.1 dB)	f = 2.0/2.5 GHz	+26.0	+29.0	1	dBm
Input Power Note1		f = 0.5 to 3.0 GHz		+29.0		dBm
1 dB Loss Compression	Pin (1 dB)	f = 2.0/2.5 GHz	+29.0	+32.0		dBm
Input Power Note2		f = 0.5 to 3.0 GHz	-	+32.0	-	dBm
Input 3rd Order Intercept Point	IIP <sub>3</sub>	f = 0.5 to 3.0 GHz, 2 tone,		+60	-	dBm
		5 MHz spicing				
Switch Control Current	I <sub>cont</sub>	No RF input	-	0.3	20	μA
Switch Control Speed	t <sub>SW</sub>	50% CTL to 90/10% RF	-	50	500	ns

Notes: 1. P<sub>in (0.1 dB)</sub> is the measured input power level when the insertion loss increases 0.1 dB more than that of the linear range.

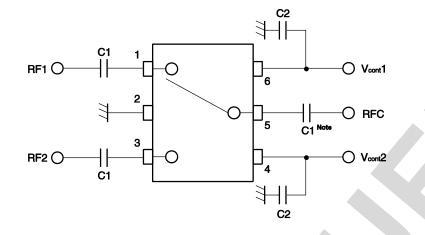
2. P<sub>in (1 dB)</sub> is the measured input power level when the insertion loss increases 1 dB more than that of the linear range.

#### CAUTION

It is necessary to use DC blocking capacitors with this device. The value of DC blocking capacitors should be chosen to accommodate the frequency of operation, bandwidth, switching speed and the condition with actual board of your system.



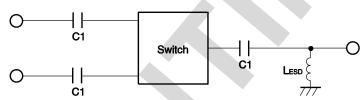
# EVALUATION CIRCUIT



Note: C1: 56 pF C2: 1 000 pF

The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

## **APPLICATION INFORMATION**

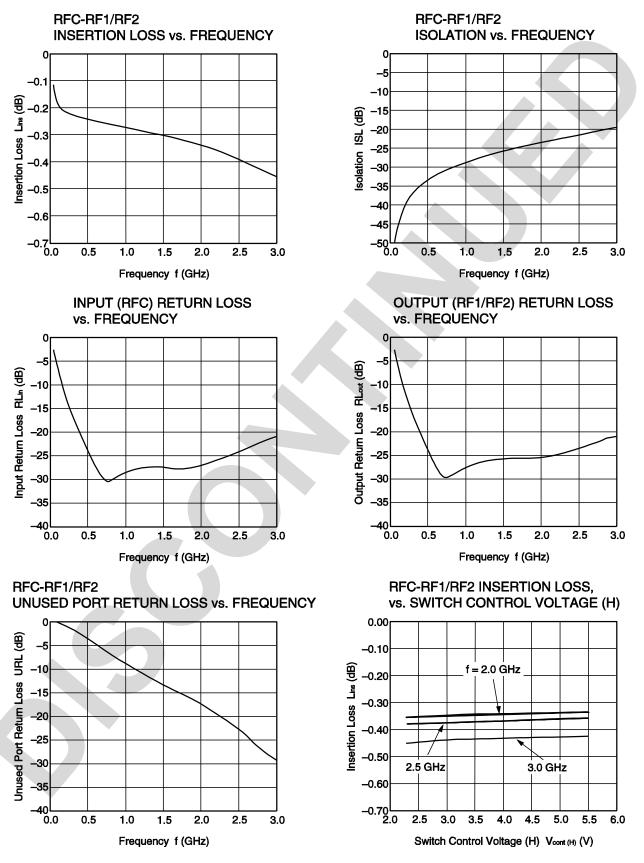


- L<sub>ESD</sub> provides a means to increase the ESD protection on a specific RF port, typically the port attached to the antenna.
- The value may be tailored to provide specific electrical responses.
- The RF ground connections should be kept as short as possible and connected to directly to a good RF ground for best performance.



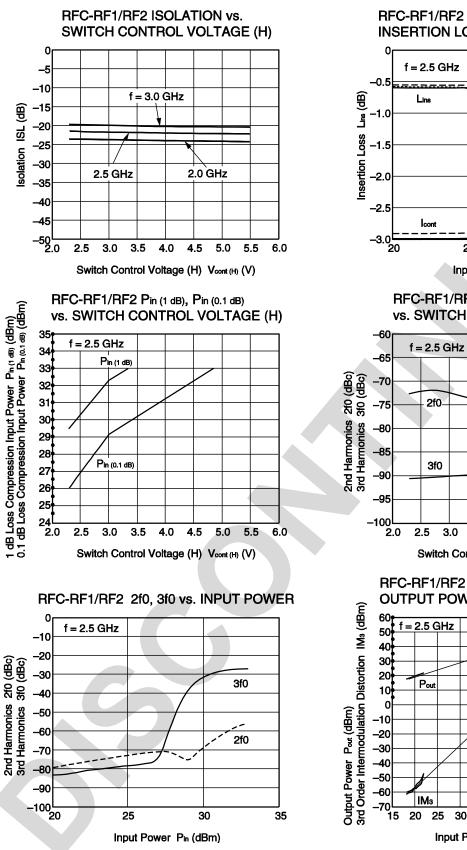
# TYPICAL CHARACTERISTICS

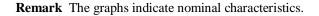
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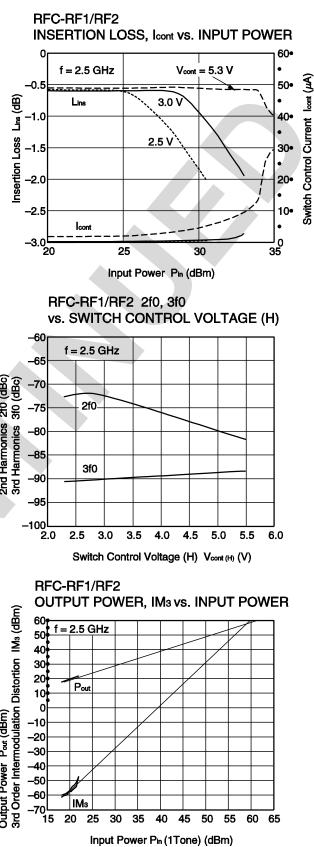






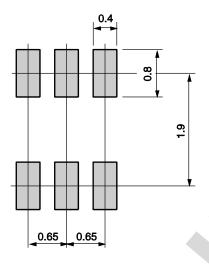






### MOUNTING PAD LAYOUT DIMENSIONS

#### 6-PIN SUPER MINIMOLD (SC-88/SOT-363 TYPE) (UNIT: mm)

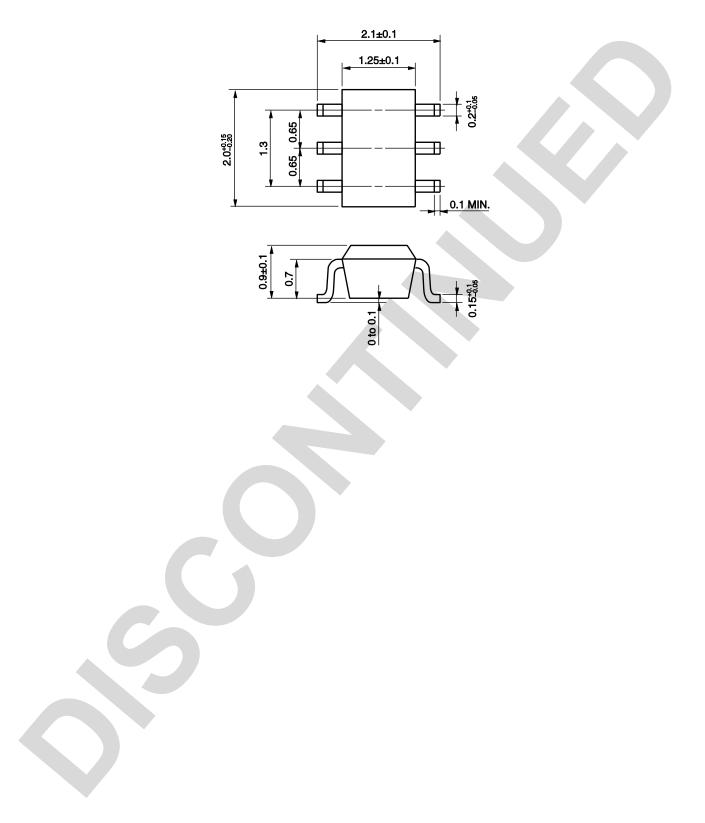


RemarkThe mounting pad layout in this document is for reference only.When designing PCB, please consider workability of mounting, solder joint reliability, prevention of solder<br/>bridge and so on, in order to optimize the design.



# PACKAGE DIMENSIONS

6-PIN SUPER MINIMOLD (SC-88/SOT-363 TYPE) (UNIT: mm)





# **RECOMMENDED SOLDERING CONDITIONS**

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions		Condition Symbol
Infrared Reflow	Peak temperature (package surface temperature)	: 260°C or below	IR260
	Time at peak temperature	: 10 seconds or less	
	Time at temperature of 220°C or higher	: 60 seconds or less	
	Preheating time at 120 to 180°C	: 120±30 seconds	
	Maximum number of reflow processes	: 3 times	
	Maximum chlorine content of rosin flux (% mass)	: 0.2%(Wt.) or below	
Wave Soldering	Peak temperature (molten solder temperature)	: 260°C or below	WS260
	Time at peak temperature	: 10 seconds or less	
	Preheating temperature (package surface temperature): 120°C or below		
	Maximum number of flow processes	: 1 time	
	Maximum chlorine content of rosin flux (% mass)	: 0.2%(Wt.) or below	
Partial Heating	Peak temperature (terminal temperature)	: 350°C or below	HS350
	Soldering time (per side of device)	: 3 seconds or less	
	Maximum chlorine content of rosin flux (% mass)	: 0.2%(Wt.) or below	

# CAUTION

Do not use different soldering methods together (except for partial heating).



#### μ**PG2418TB**

Caution GaAs Products	This product uses gallium arsenide (GaAs). GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.
	<ul> <li>Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.</li> </ul>
	<ol> <li>Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.</li> </ol>
	2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
	Do not burn, destroy, cut, crush, or chemically dissolve the product.
	Do not lick the product or in any way allow it to enter the mouth.



Revision	History
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# $\mu$ PG2418TB Data Sheet

		Description	
Rev.	Date	Page Summary	
1.00	Aug 24, 2010	-	First edition issued

Bluetooth is a trademark owned by Bluetooth SIG, Inc., U.S.A.

# **Mouser Electronics**

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